

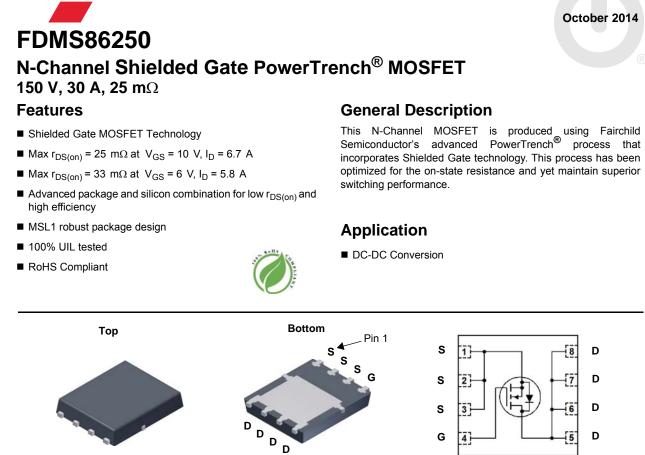
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Power 56

## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Param	eter		Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			150	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T <sub>C</sub> = 25 °C		30		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	6.7	Α	
	-Pulsed		(Note 4)	100		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	180	mJ	
D	Power Dissipation	T <sub>C</sub> = 25 °C		96	w	
PD	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Tempera	ature Range		-55 to +150	°C	

#### **Thermal Characteristics**

FAIRCHILD

ł	$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.3	°C/W	
ł	$R_{ heta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 50	0/10	

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86250	FDMS86250	Power 56	13 "	12 mm	3000 units

FDMS86250 N-Channel Shielded Gate PowerTrench $^{\textcircled{R}}$  MOSFET

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	150			V
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		106		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
	acteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	2.0	2.9	4.0	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage		-	11		m)//°C
$\Delta T_{J}$	Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		-11		mV/°C
r <sub>DS(on)</sub>		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.7 \text{ A}$		19	25	
	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 5.8 A$		23	33	mΩ
-		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.7 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		35	46	0
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 6.7 A		24		S
-	Characteristics					
C <sub>iss</sub>	Input Capacitance			1750	2330	pF
C <sub>oss</sub>	Output Capacitance	── V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, f = 1 MHz		165	220	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			8.8	15	pF
R <sub>g</sub>	Gate Resistance			0.5		Ω
	a Characteristics					
Switchin	u Characterístics					
	g Characteristics			14	25	ns
t <sub>d(on)</sub>	Turn-On Delay Time Rise Time	Voo = 75 V lo = 6 7 A			25 10	ns ns
t <sub>d(on)</sub> t <sub>r</sub>	Turn-On Delay Time Rise Time	$V_{DD}$ = 75 V, I <sub>D</sub> = 6.7 A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		14 4.3 22	-	_
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 6.7 A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		4.3	10	ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		4.3 22 4.2	10 35	ns ns ns
t <sub>d(on)</sub> t <u>r</u> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{GS}$ = 10 V, R <sub>GEN</sub> = 6 Ω V <sub>GS</sub> = 0 V to 10 V		4.3 22	10 35 10	ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		4.3 22 4.2 25	10 35 10 36	ns ns ns nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 Ω $V_{GS}$ = 0 V to 10 V $V_{GS}$ = 0 V to 5 V $V_{DD}$ = 75 V,		4.3 22 4.2 25 14	10 35 10 36	ns ns nS nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 Ω $V_{GS}$ = 0 V to 10 V $V_{GS}$ = 0 V to 5 V $V_{DD}$ = 75 V,		4.3 22 4.2 25 14 7.4	10 35 10 36	ns ns nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 75 \text{ V},$ $I_D = 6.7 \text{ A}$		4.3 22 4.2 25 14 7.4 5.5	10 35 10 36 20	ns ns nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $I_D = 75 \text{ V},$ $I_D = 6.7 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 2 \text{ A}  (\text{Note } 2)$		4.3 22 4.2 25 14 7.4 5.5	10 35 10 36 20 1.2	ns ns nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-So	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 75 \text{ V},$ $I_D = 6.7 \text{ A}$		4.3 22 4.2 25 14 7.4 5.5	10 35 10 36 20	ns ns nC nC nC nC



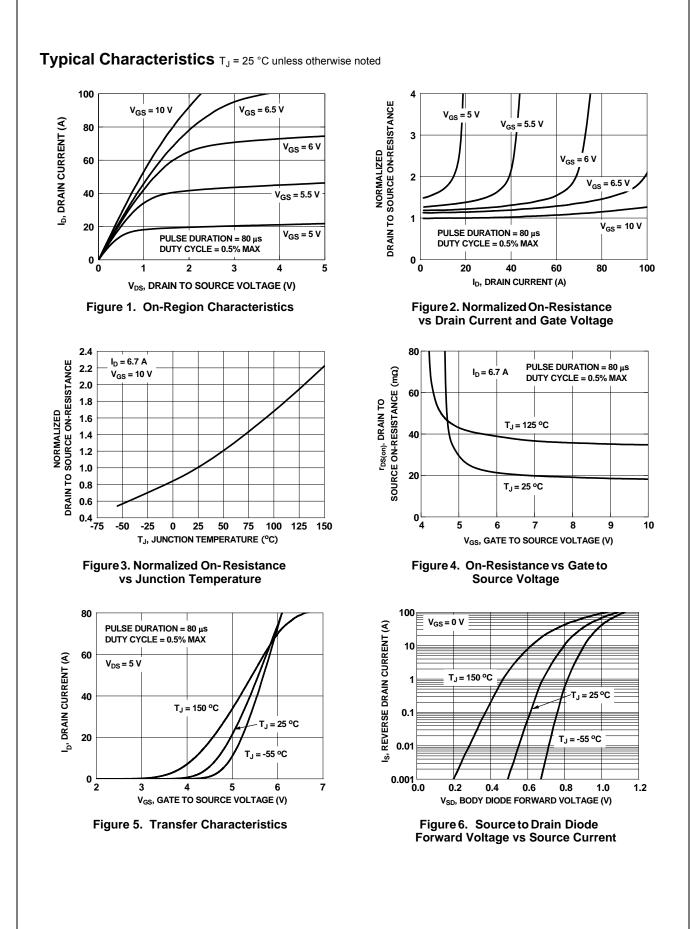
2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

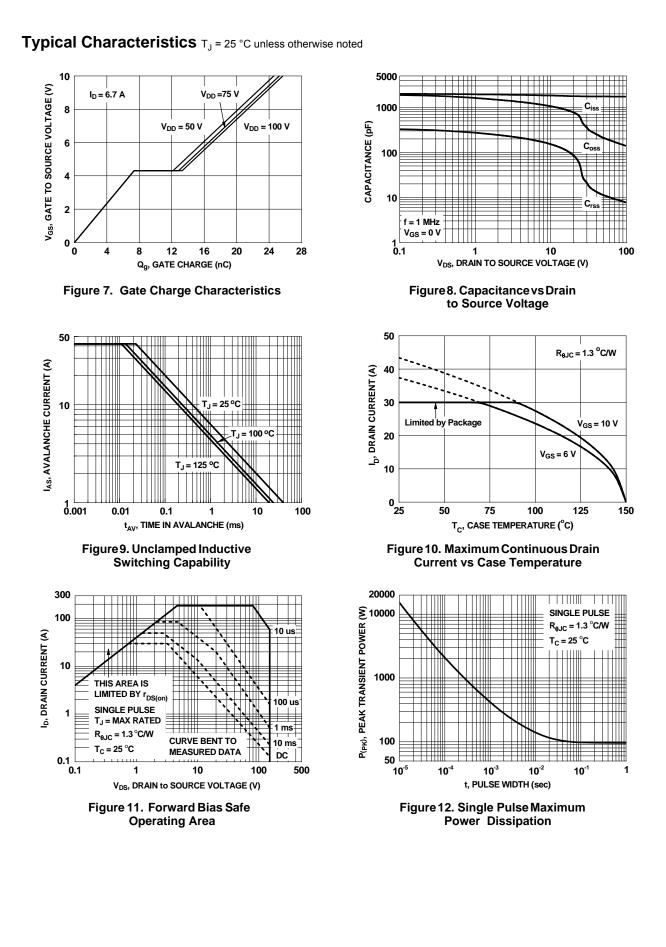
3. Starting T\_J = 25 °C, L = 1 mH, I\_{AS} = 19 A, V\_DD = 135 V, V\_GS = 10 V.

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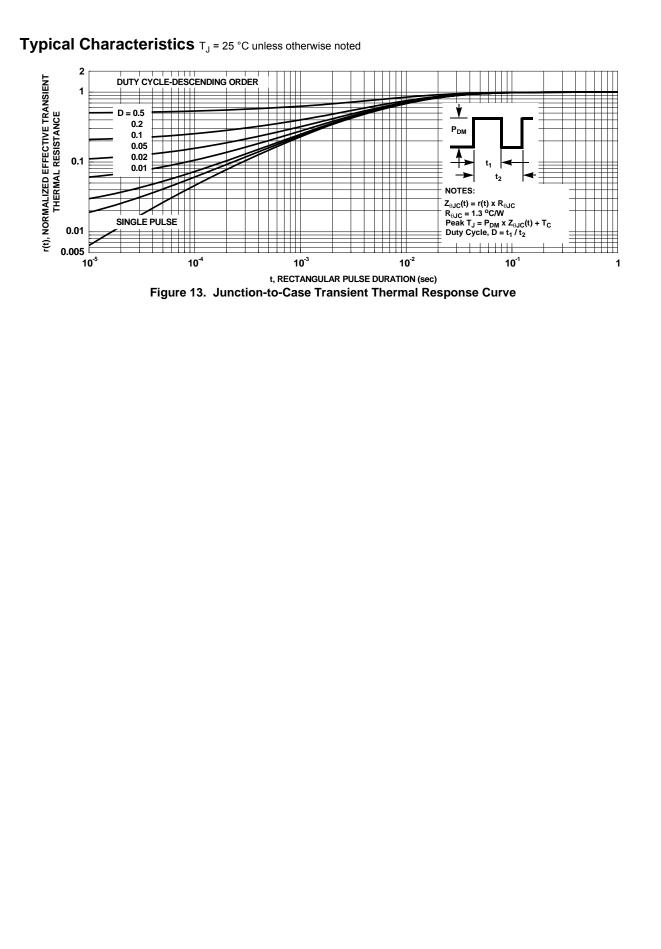
4. Pulse Id limited by junction temperature, td ≤ 100  $\mu$ s. Please refer to SOA curve for more details.

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